Assembly Instructions MP-8M Memory Board

Introduction

The MP-8M Memory Board is a 5 $1/2" \times 9"$ double sided plated thru hole board with a total storage capability of 8,192 (8K) words of a 8 bit random access memory. The circuitry on the board provides all of the address decoding and data line buffering to handle a total of 16 4K (4K bit x 1 bit) static random access memory integrated circuits. All interconnections to the system are made via a 50 pin connector to the Mother Board (MP-B). +5 volt power for the board is supplied by two on board regulators. Current consumption for the entire board (8K of memory plus decoder/buffer) is approximately 1.5 amp.

When the SWTPC 6800 Computer System is being assembled, work on only one board at a time. Each of the system's boards and their associated parts must not be intermixed to avoid confusion during assembly. The MOS integrated circuits supplied with this kit are susceptible to static electricity damage and for this reason have been packed with their leads impressed onto a special conductive foam or possible wrapped in a conductive foil. In either case, do not remove the protective material until specifically told to do so later in the instructions.

PC Board Assembly

Note: Since all of the holes on the PC board have been plated thru, it is only necessary to solder the components from the bottom side of the board. The plating provides the electrical connection from the "BOTTOM" to the "TOP" foil of each hole. Unless otherwise noted it is important that none of the connections be soldered until all of the components of each group have been installed on the board. This makes it much easier to interchange components if a mistake is made during assembly. Do not use acid core solder or any type of paste flux. We will not guarantee or repair any kit on which either product has been used. Use only the solder supplied with the kit or a 60/40 alloy resin core equivalent. Remember all of the connections are soldered on the bottom side of the board only. The plated thru holes provide the electrical connection to the top foil.

- () Before installing any parts on the circuit board, check both sides of the board over carefully for incomplete etching and foil "bridges" or "breaks". It is unlikely that you will find any but should there be one especially on the "TOP" side of the board it will be very hard to locate and correct after all of the components have been in-stalled on the board.
- () Attach all of the resistors to the board. As with all other components unless noted, use the parts list and component layout drawing to locate each part and install from the "TOP" side of the board bending the leads along the "BOTTOM" side of the board and trimming so that 1/16" to 1/8" of wire remains. Solder.

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- () Install all of the capacitors on the board. Be sure to orient the electrolytic capacitor correctly. The polarity is indicated on the component layout drawing. Solder.
- () Starting from one end of the circuit board install each of the five, 10 pin Molex female edge connectors along the lower edge of the board. These connectors must be inserted from the "TOP" side of the board and must be pressed down firmly against the board. Make sure the body of the connector seats firmly against the circuit board and that each pin extends completely into the holes on the circuit board. Not being careful here will cause the board to either wobble and/or be crooked when plugged onto the mother board. It is suggested that you solder only the two end pins of each of the five connectors until all have been installed at which time if everything looks straight and rigid you should solder the as yet unsoldered pins.
- () Insert the small nylon indexing plug into the edge connector pin indicated by the small triangular arrow on the "BOTTOM" side of the circuit 'board. This prevents the board from being accidentally plugged onto the mother board incorrectly.
- () Install switches S1 and S2 on the circuit board. Be sure to install switch S2 so the switches are ON when the paddles are nearer the TOP edge of the MP-8M circuit board. Solder.
- () Install integrated circuits IC16 thru IC22. As each one is installed make sure it is down firmly against the board and solder only two of the leads to hold the pack in place while the other IC's are being inserted. Be very careful to install each in its correct position. Do not bend the leads on the back side of the board. -- Doing so makes it very difficult to remove the integrated circuits should replacement ever be necessary. The semicircle notch or dot on the end of the package is used for orientation purposes and must match with the outlines shown on the component layout drawing for each of the IC's After inserting all of the integrated circuits go back and solder each of the as yet unsoldered pins.
- () Install integrated circuits IC23 and IC24 on the circuit board. These components must be oriented so their metal face is facing the circuit board with the small metal heatsink sandwiched between the two on both. The heatsink and IC are secured to the circuit board with a #4-40 x 1/4" screw, lockwasher and nut. The three leads of the integrated circuit must be oriented as shown in the component layout drawing. Solder.

NOTE: MOS integrated circuits are susceptible to damage by static electricity. Although some degree of protection is provided internally within the integrated circuits, their cost demands the utmost in care. Before opening and/or installing any MOS integrated circuits you should ground your body and all metallic tools coming into contact with the leads, thru a 1 M ohm 1/4 watt resistor (supplied with the kit). The ground must be an "earth" ground such as a water pipe, and not the circuit board ground. As for the connection to your body, attach a clip lead to your watch or metal ID bracelet. Make absolutely sure you have the 1 Meg ohm resistor connected between you and the "earth" ground, otherwise you will be creating a dangerous shock hazard. Avoid touching the leads of the integrated circuits any more than necessary when installing them, even if you are grounded. On those MOS IC's being soldered in place; the tip of the soldering iron should be grounded as well separately from your body ground) either with or without a 1 Meg ohm resistor. Most soldering irons-having a three prong line cord plug already have a grounded tip. Static electricity should be an important consideration in cold, dry environments. It is less of a problem when it is warm and humid.

- () Install MOS integrated circuits ICO thru IC15 following the precautions given in the preceding section. As each is installed, make sure it is down firmly against the board before soldering all of its leads. Be very careful to install each in its correct position. Do not -- bend the leads on the back side of the board. Doing so makes it very difficult to remove the integrated circuits should replacement ever be necessary. The "dot" or "notch" on the end of the package is used for orientation purposes and must match with that shown on the component layout drawing for each of the IC's.
- () Now that all of the components have been installed on the board, double check to make sure that all have been installed correctly in their proper location.
- () Check very carefully to make sure that all connections have been soldered. It is very easy to miss some connections when soldering which can really cause some hard to find problems later during check out. Also look for solder "bridges" and "cold" solder joints which are another common problem.

This completes the assembly of the MP-8M board. Since the circuit board now contains MOS devices it is susceptible to damage from severe static electrical sources. One should avoid handling the board any more than necessary and when you must, avoid touching or allowing ANYTHING to come into contact with any of the conductors on the board.

MP-8M Memory Board Checkout Procedure

<u>NOTE</u>: Before checking out the MP-8M memory board, it must be switch programmed for the proper address selection using switch S2. To set the switches, initially set all of the switches off. To program the board for the 0-8K range, flip the switch adjacent the number 16 ON: for the 8K-16K range, flip the switch adjacent the number 16 ON: for the 16K-24K range, flip the switch adjacent the number 24 ON: for the 24K-32K range, flip the switch adjacent the number 32 ON. Only one switch may be ON at a time otherwise the board will respond to more than one range of addresses. Make sure the WRITE PROTECT switch, S1, is in the NORMAL position. If you have MP-M memory boards in your system, you may have to reconfigure the MP-M boards so their address decoding does not conflict with those addresses assigned to the MP-8M memory boards. You should program your memory boards so your system has <u>continuous</u> memory starting from location 0000; going as high as your memory supply allows. Use the MP-8M boards for your low memory and the MP-M board for upper memory. 32K of memory is the maximum you may have in the SWTPC 6800 Computer System. Just for your own information the MP-8M memory board consumes about the same power as a fully expanded MP-M board while providing twice as much memory.

- () Set the selected address switch as described before.
- () Remove the system's AC power if applied.
- () Check over the MP-8M Memory board to see that all connections have been soldered and that there are no solder or foil conductor "bridges" or "breaks".
- () Looking at the MP-B Mother board from the front of the chassis and with the MP-8M Memory board oriented so you are viewing the "TOP" side, set the board down lightly on one of the connector rows of the mother board. Electrically the board may be plugged onto any one of the seven main board positions. Check to see that the index pin on both the MP-B board and the MP-8M board align. They should align, if not, there is a mistake.
- () Assuming the index pin aligns, press the MP-8M board down perpendicular onto the mother board. Be sure the MP-8M board seats firmly against the mother board.
- () Again apply AC power to the unit. Using one of the GND pins on the mother board as a reference, measure the voltage on the right most lead of the voltage regulators IC23 and IC24 on the MP-8M board. The reading should be +5 V DC 5%. If not, something is wrong.
- () Enter and run the ROBIT and MEMCON memory diagnostic programs listed in the software section of the System Documentation Notebook. Use the tables listed at the end of this instruction set to determine the proper starting and ending memory addresses to be entered for the programs. For example, if the memory board to be tested is board address selected for the 0 to 8K range, then the lowest address on the board is 0000 and the highest address is 1FFF. If either of the programs indicate errors, you can re-run the diagnostics on 4,096 word increments of memory to help pinpoint the source of the problem. There is always the chance of a bad IC but experience has shown that most problems will be the result of a solder or foil conductor "bridge" or "break". So get out the magnifying glass and check the board over very carefully if you have a problem. The most thorough memory diagnostic available at the time of this writing is CDAT-1. A copy of this diagnostic is being included in this instruction set.

Write Protect Feature

The MP-8M memory board is provided with a write protect switch which allows the user to prevent the contents of the entire memory board from being changed once the switch has been flipped to the PROTECT position. The contents of memory will still be lost of course if and when the system is ever powered down. Since the write protect feature is rarely used, you will normally operate the board with the write protect switch in the NORMAL position.

How It Works

Each of the memory chips on the board is a 1 x 4096 bit static random access memory IC storing one of the eight bits of each word within one of the two, 4,096 word memory halves. The actual bit and half assignment of each memory IC is given in the table at the end of this instruction set. The twelve address lines A0 thru All, as well as the R/W lines of all of the memory IC's on each board are paralleled. Because of the large capacitances generated by this paralleling, integrated circuits IC19 and IC20 are used as non-inverting buffers to drive the forementioned lines. The actual address selection for each of the two eight bit 4,096 word halves is done using integrated circuits IC18, IC21 and IC22.

Since the eight bit data buss for the computer system is bi-directional, bi-directional transceiver/buffers IC16 and IC17 buffer the incoming and outgoing data to and from the memory board to the data buss. Integrated circuits IC21 and IC22 enable the outgoing sections of the bi-directional transceivers at the appropriate times while the incoming sections of the bi-directional transceivers are enabled at all times since the memory IC's have separate input/output lines. +5 volt power for the decoders and buffers (IC16 - IC22) is supplied by voltage regulator IC23 while +5 volt power for the memories is supplied by voltage regulator IC24. The various capacitors are used on the board to reduce power supply buss noise.

Board Select 8	Half of Memory lower upper	Starting Address 0000 1000	Ending Address OFFF 1FFF
16	lower	2000	2FFF
	upper	3000	3FFF
24	lower	4000	4FFF
	upper	5000	5FFF
32	lower	6000	6FFF
	upper	7000	7FFF

MP-8M Memory Address Assignment Table (hex)

MP-8M Memory IC Assignment Table

		<u>bit 7</u>	bit 6	bit 5	bit 4	bit 3	<u>bit 2</u>	<u>bit 1</u>	<u>bit 0</u>
Lower	4K	IC 7	IC 5	IC 5	IC 4	IC 3	IC 2	IC 1	IC 0
Upper	4K	IC 15	IC 14	IC 13	IC 12	IC 11	IC 10	IC 9	IC 8

Hex to Binary Conversion

00	hex	=	0000	0000	binary	08	hex	=	0000	1000	binary
01	hex	=	0000	0001	binary	10	hex	=	0001	0000	binary
02	hex	=	0000	0010	binary	20	hex	=	0010	0000	binary
04	hex	=	0000	0100	binary	40	hex	=	0100	0000	binary
						80	hex	=	1000	0000	binary

Parts List MP-8M Memory Board

 Rl R2	Resistors 1K ohm 1/4 watt resistor "
	Capacitors
 C1 C2 C3	0.1 mfd capacitor
 C4	n
 C5	N
 C6	n,
 C7	n
 C8*	100 mfd @ 16VDC electrolytic capacitor
	Integrated Circuits
 IC0*	TMS4044 4K x 1 static memory or equiv.
 IC1*	N
 IC2*	n
 IC3*	u
 IC4*	n
 IC5*	u
 IC6*	n
 IC7*	n .
 IC8*	n
 IC9*	n .
 IC10*	n .
 IC11*	n
 IC12*	n
 IC13*	u .
 IC14*	u .
 IC15*	
 IC16*	DM8835 bi-directional transceiver
 IC17*	
 IC18*	748138 decoder
 IC19*	DM8097 or 74367 buffer
 IC20*	
 IC21*	7400 quad NAND gate
 IC22*	7410 triple NAND gate
 IC23*	7805 5 VDC voltage regulator
 IC24*	
	Switches
S1*	SPDT miniature toggle switch
 c.) *	1 pogition DID gwitch

S2* 4 position DIP switch

Dual Address Memory Test CDAT By John Christensen

The CDAT memory diagnostic can be used to help locate memory problems in a SWTPC 6800 computer system that MEMCON and ROBIT may miss. The program itself resides entirely within the 128 byte MIKBUG RAM. The program must be loaded in two parts to avoid interfering with the systems push down stack. The contiguous section of memory to be tested is set by loading the most significant byte of the lower memory address into A002, the least significant byte into A003, the most significant byte of the upper memory address in A004 and its least significant byte in A005. The low address must be less than or equal to the upper address.

The test starts from the low address and writes a 00 into all memory up to the high address. An FF is then written into the first address and all other locations are checked to be sure they contain 00. If all are OK the FF is replaced with a 00 and an FF is written in the next memory location. This pattern continues until all memory is checked or an error is found. If the computer returns to MIKBUG, then no errors were found.

If the program displays a register dump then a problem was discovered on the board. The register dump should look similar to the following:

ADDRESS ERROR MSG. V V F3 00 FF 0400 A079 A042.

The important parts of the dump are the ADDRESS and the ERROR MSG. areas, as denoted above. The error messages are interpreted as follows:

A077 Error on initial test pattern (can't write 0's into mem.) A078 Error on second test pattern (can't write FF's into mem.) A079 Dual address error low A07A Dual address error high

If a dual address error is found then writing into one memory location affects another. For example, if ADDRESS = 0400 and A016 contains 0410 then writing into 0400 will change the contents of 0418 or vice-versa. (A016 is a temporary index register storage location within the program that you can compare with ADDRESS in the register dump to see which two memory locations caused the error). The IC assignments table included with the memory board instructions can then be used to help locate the problem by comparing the bit pattern of the locations in error.

The CDAT program takes some time to run, so run the diagnostic over only one complete board at a time.

MEM. SIZE	APPROX. RUN TIME
1K	29 sec.
2K	1 min. 53 sec.
3К	4 min. 13 sec.
4K	7 min. 29 sec.
8K	more than 30 min.

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	NAM	CDAT-1	
			CHRISTENSEN'S)
EOE3	CONTRL EQU	\$E0E3	
A002	ORG	\$A002	
A002	LOTEMP RMB	2	STARTING ADDRESS
A004	HITEMP RMB	2	ENDING ADDRESS
A014	ORG	\$A014	
A014 00	INIPAT FCB	0	INITIAL TEST PATTERN
A015 FF	TESPAT FCB	\$FF	TEST PATTERN
A016	IXRTMP RMB		IXR TEMPORARY STORAGE
A018 FE A0 02	START LDX	LOTEMP	
A01B B6 A0 14	LDA A	INIPAT	
A01E A7 00	LOOP1 STA A	0,X	
A020 A1 00	CMP A	0,X	
A022 26 53	BNE	ERPNT1	
A024 BC A0 04	CPX	HITEMP	
A027 27 03	BEQ	LOAPAT	
A029 08	INX		
A02A 20 F2		LOOP1	
A02C FE A0 02	LOAPAT LDX	LOTEMP	
A02F F6 A0 15	LDA B	TESPAT	
A032 E7 00	LOOP4 STA B	0,X	
A034 20 14	BRA		
A048	ORG	\$A048	
A048 A0 18	FDB	START	
	CHECK CMP B		
A04C 26 2A	BNE	ERPNT2	
A04E FF A0 16		IXRTMP	
A051 BC A0 02			
A054 27 07	BEQ	CHCKHI	
A056 09	DEX	0	
A057 A1 00	CMP A		
A059 26 1E	BNE	ERPNT3	
A05B 20 F4	BRA	LOOP2	
A05D FE A0 16	CHCKHI LDX	IXRTMP HITEMP	
A060 BC A0 04	CPX	HIJEMP	
A063 27 16	BEQ	END	
A065 08	LOOP3 INX	0 11	
A066 A1 00	CMP A		
A068 26 10	BNE	ERPNT4	
A06A BC A0 04	CPX	HITEMP	
A06D 26 F6	BNE	LOOP3	
A06F FE A0 16	RESTRE LDX	IXRTMP	
A072 A7 00	STA A	0,X	
A074 08 A075 20 BB	INX		
A075 20 BB A077 3F	BRA FDDNT1 GWI	LOOP4	דאריקייייינית ראדיייייייייייייייייייייייייייייייייייי
A077 3F A078 3F	ERPNT1 SWI ERPNT2 SWI		ERROR ON INITIAL PATTERN ERROR ON TEST PATTERN
A078 3F A079 3F	ERPNT2 SWI ERPNT3 SWI		DUAL ADDRESS ERROR LOW
A07A 3F	ERPNIS SWI ERPNT4 SWI		DUAL ADDRESS ERROR LOW DUAL ADDRESS ERROR LO
A07B 7E E0 E3	END JMP	CONTRL	OT NOVE CONTROL TO
		CONTINE	